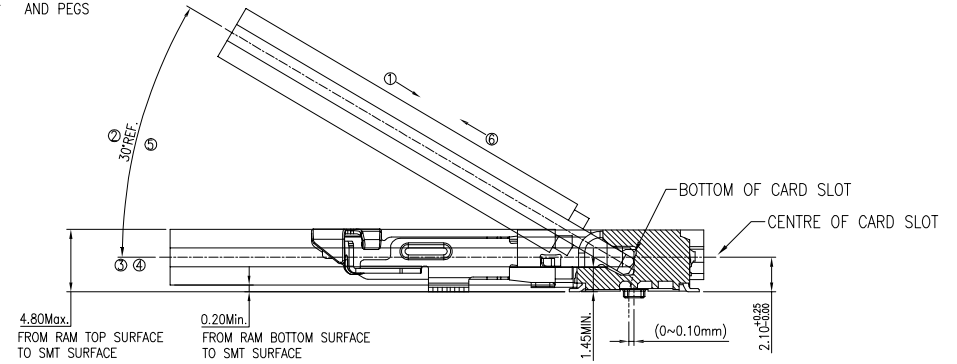
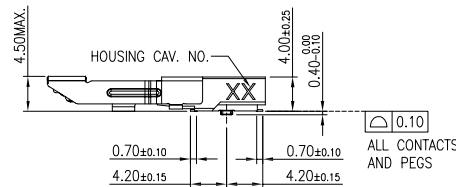
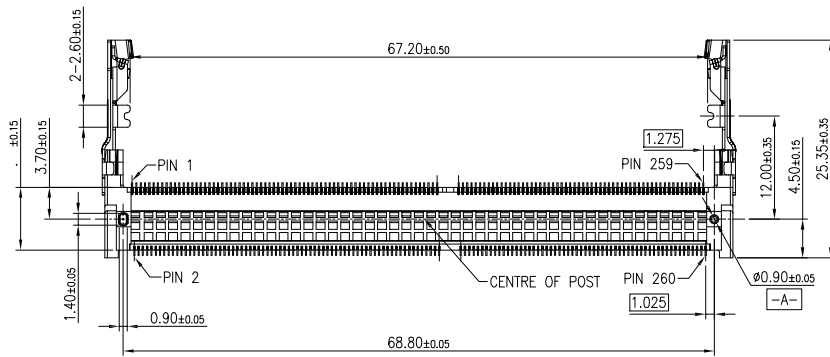
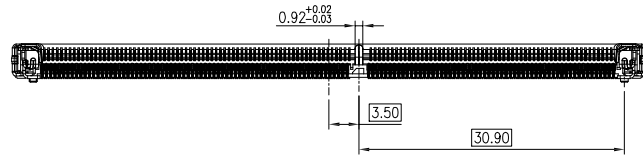
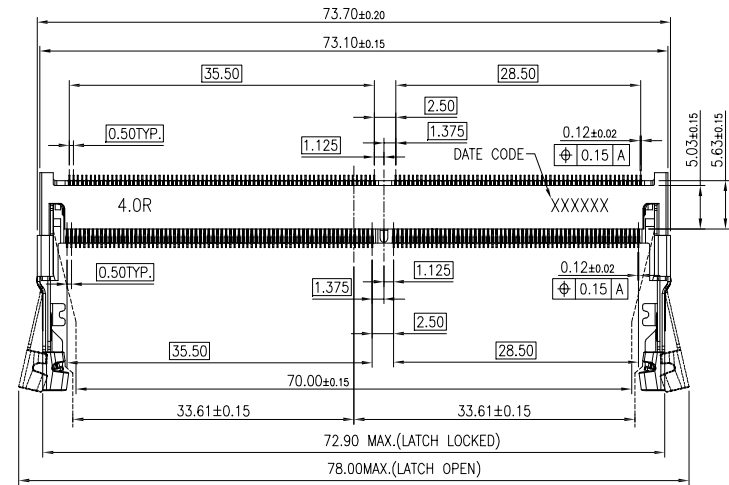




NOTES

1.MATERIAL

- 1-1 HOUSING:LCP THERMOPLASTIC,UL94V-0. COLOR:BLACK.
- 1-2 CONTACT:HIGH-PERFORMANCE COPPER ALLOY.
- 1-3 LATCH:STAINLESS STEEL.
- 1-4 PEG:STAINLESS STEEL.

2.FINISH

- 2-1 CONTACT:GOLD PLATING 1~3u" ON CONTACT AREA AND 1~3u"GOLD PLATING ON SOLDER AREA NICKEL 50u"~150u" UNDER-PLATING ALL OVER
- 2-2 PEG:50~150u" TIN PLATING OVER 50~150u" NICKEL UNDER-PLATING ALL OVER

3.MSL LEVEL: MSL(MOISTURE SENSITIVITY LEVEL)=1.

4.IR REFLOW:

THE PEAK TEMPRATURE ON THE BOARD SHALL BE MAINTAINED FOR 10 SECONDS AT 260±5°C.

TOLERANCE		UMax conn 东莞市友贸实业有限公司 DONGGUAN UMAX ENTERPRISE LIMITED		TITLE: DDR4 SODIMM 4.0H 260PIN REVERSE G/F TYPE.			
LINEAR	ANGLES			PART NO. D4260-4001RR			
X±0.40	X°± 3°	APPD: Jason	MAT'L:	DWG NO. C-D4260-40R			
.X±0.30	.X*±	CHKD: Schumi	FINISH:				
REV	ECN NO.	NAME	DATE	DRWN:Lei Songping	Q'TY:	MATING/UNMATING VIEW SCALE 2:1	
A1	-----	FENG.PF	Oct.23.2023			UNITS	SCALE
						MM	1 : 1
						SHEET	1 OF 2
						REV	A1

CUSTOMER

